

MOSFET Maximum Ratings T_J = 25°C unless otherwise noted.

Symbol	Parameter	Ratings	Units	
V _{DSS}	Drain-to-Source Voltage		40	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	25	•
D	Pulsed Drain Current	T _C = 25°C	See Figure 4	Α
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	43.2	mJ
D	Power Dissipation		48.4	W
P _D Derate Above 25°C			0.32	W/ºC
T _J , T _{STG}	Operating and Storage Temperature	-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		3.1	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	52	°C/W

Notes:

1: Current is limited by bondwire configuration.

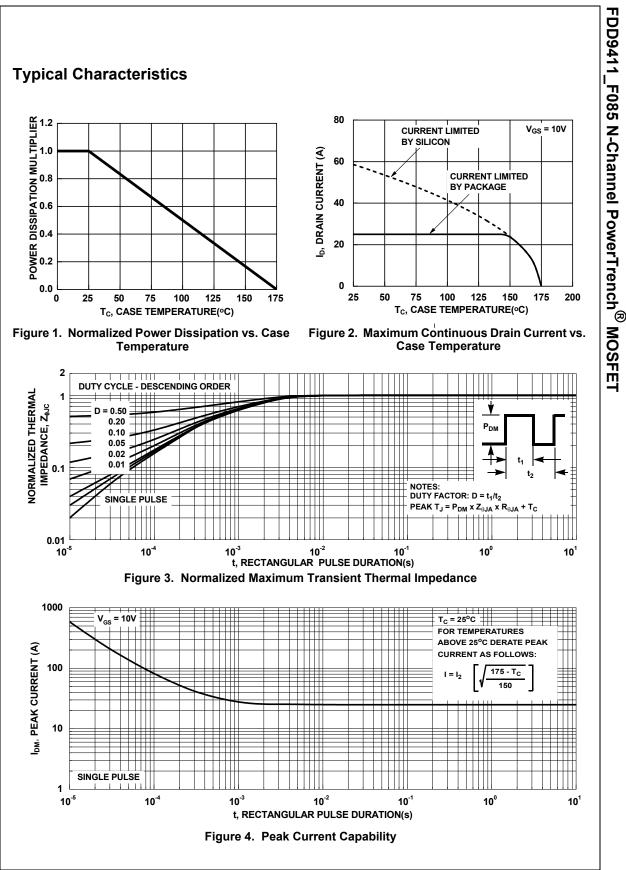
2: Starting $T_J = 25^{\circ}$ C, L = 0.6mH, $I_{AS} = 12A$, $V_{DD} = 40V$ during inductor charging and $V_{DD} = 0V$ during time in avalanche.

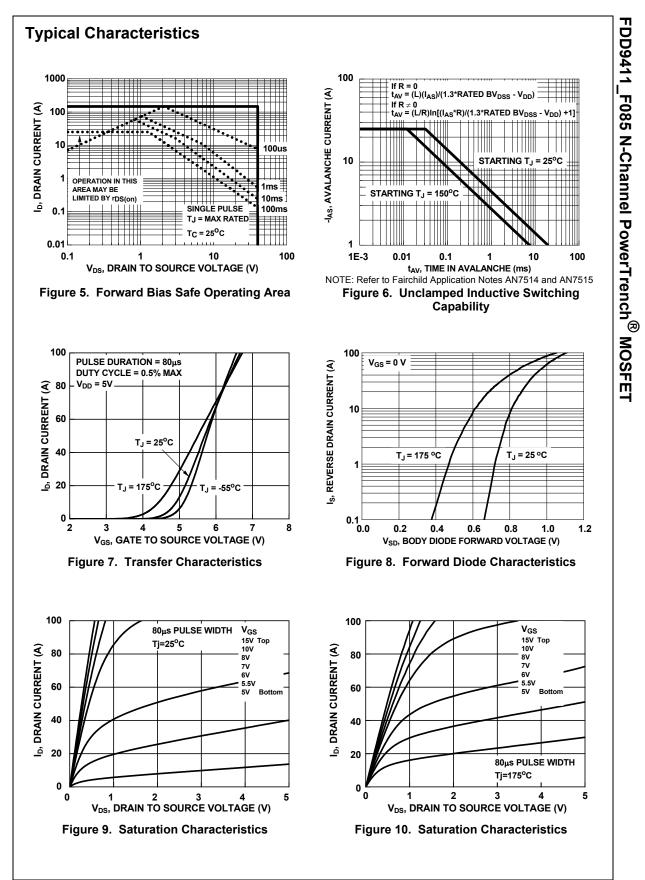
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

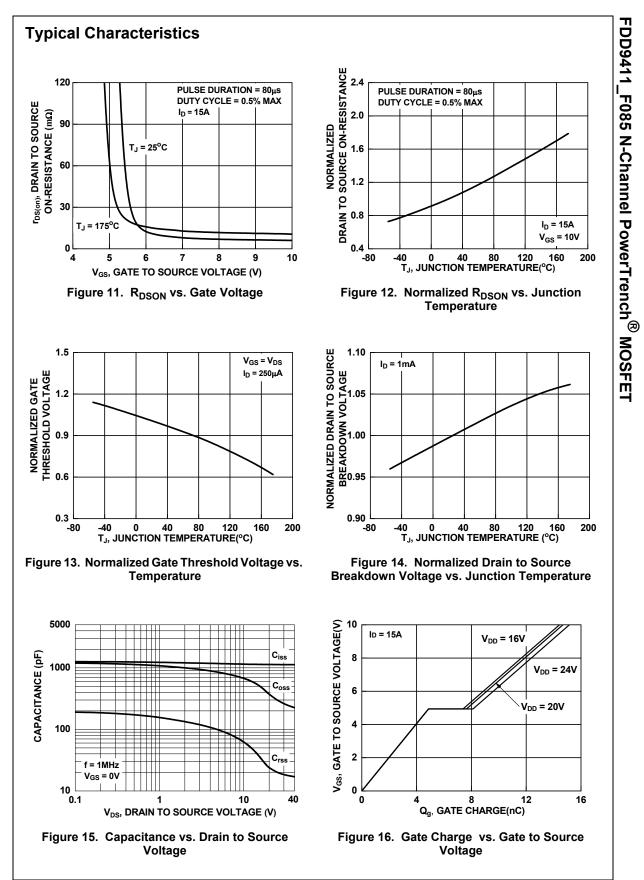
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD9411	FDD9411_F085	D-PAK(TO-252)	13"	16mm	2500units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA,	V _{GS} = 0V	40	-	-	V
	-	V _{DS} =40V,		-	-	1	μA
IDSS	Drain-to-Source Leakage Current	burce Leakage Current $V_{GS} = 0V$ $T_J = 175^{\circ}C$ (Note		-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} ,	l _D = 250μA	2.0	3.4	4.0	V
	Drain to Source On Desistance	I _D = 15A,		-	6.2	7.8	mΩ
R _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V		-	11.2	14	mΩ
Dynami	c Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	1080	-	pF
C _{oss}	Output Capacitance			-	340	-	pF
C _{rss}	Reverse Transfer Capacitance			-	22	-	pF
R _g	Gate Resistance	f = 1MHz		-	2.6	-	Ω
Q _{g(ToT)}	Total Gate Charge	$V_{GS} = 0 \text{ to } 10V \qquad V_{DD} = 32V \\ V_{GS} = 0 \text{ to } 2V \qquad I_D = 15A$		-	15	22.5	nC
Q _{g(th)}	Threshold Gate Charge			-	2	-	nC
Q _{gs}	Gate-to-Source Gate Charge			-	5.3	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			-	2.8	-	nC
Switchi	ng Characteristics						
t _{on}	Turn-On Time		_	-	-	24	ns
t _{d(on)}	Turn-On Delay		-	-	8.7	-	ns
t _r	Rise Time	V _{DD} = 20V,	I _D = 15A,	-	7.2	-	ns
t _{d(off)}	Turn-Off Delay	V _{GS} = 10V,	R _{GEN} = 6Ω	-	15.8	-	ns
t _f	Fall Time		-	-	4.4	-	ns
t _{off}	Turn-Off Time			-	-	30	ns
Drain-S	ource Diode Characteristics						
	Source-to-Drain Diode Voltage	I _{SD} = 15A, V _{GS} = 0V		-	-	1.25	V
Vap		I _{SD} = 7.5A, ¹		-	-	1.2	V
V _{SD}	Source-to-Drain Diode Voltage	00 ;	V _{DD} = 32V, I _F = 15A,		35	53	ns
V _{SD} t _{rr}	Reverse-Recovery Time Reverse-Recovery Charge			-	- 55	55	113







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